

PHOTOCOUPLER PS9117A

HIGH CMR, 10 Mbps OPEN COLLECTOR OUTPUT TYPE 5-PIN SOP (SO-5) HIGH-SPEED PHOTOCOUPLER

-NEPOC Series-

DESCRIPTION

The PS9117A is an optically coupled high-speed, active low type isolator containing a GaAlAs LED on the input side and a photodiode and a signal processing circuit on the output side on one chip.

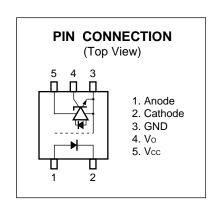
The PS9117A is designed specifically for high common mode transient immunity (CMR) and low pulse width distortion. The PS9117A is suitable for high density application.

FEATURES

- Pulse width distortion (tphl tplh = 35 ns MAX.)
- High common mode transient immunity (CM_L, CM_L = ± 15 kV/ μ s MIN.)
- Small package (SO-5)
- High-speed (10 Mbps)
- High isolation voltage (BV = 3 750 Vr.m.s.)
- · Open collector output
- Ordering number of taping poduct: PS9117A-F3: 2 500 pcs/reel
- Pb-Free product
- Safety standards
 - UL approved: File No. E72422
 - DIN EN60747-5-2 (VDE0884 Par2) approved No. 40008902 (Option)
 - CSA approved: File No. 2115283 (CA 101391)

APPLICATIONS

- Measurement equipment
- PDP
- FA Network

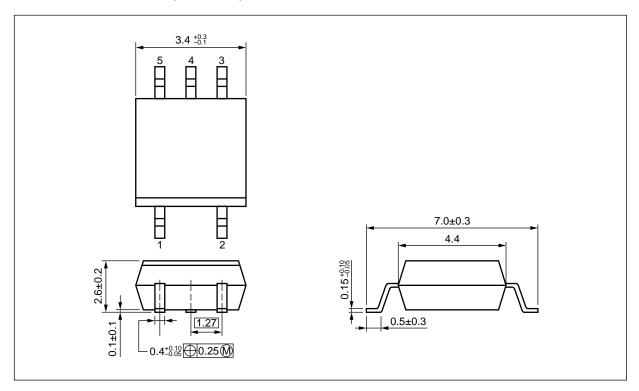


TRUTH TABLE

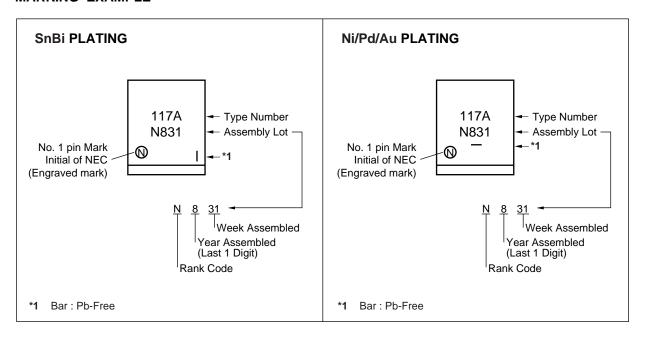
LED	Output				
ON	L				
OFF	Н				

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PACKAGE DIMENSIONS (UNIT: mm)



<R> MARKING EXAMPLE



<R> ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standards Approval	Application Part Number*1
PS9117A	PS9117A-A	Pb-Free	20 pcs (Tape 20 pcs cut)	Standard products	PS9117A
PS9117A-F3	PS9117A-F3-A	(SnBi)	Embossed Tape 2 500 pcs/reel	(UL approved)	
PS9117A-V	PS9117A-V-A		20 pcs (Tape 20 pcs cut)	DIN EN60747-5-2	
PS9117A-V-F3	PS9117A-V-F3-A		Embossed Tape 2 500 pcs/reel	(VDE0884 Part2)	
				approved (Option)	
PS9117A	PS9117A-AX	Pb-Free	20 pcs (Tape 20 pcs cut)	Standard products	
PS9117A-F3	PS9117A-F3-AX	(Ni/Pd/Au)	Embossed Tape 2 500 pcs/reel	(UL approved)	
PS9117A-V	PS9117A-V-AX		20 pcs (Tape 20 pcs cut)	DIN EN60747-5-2	
PS9117A-V-F3	PS9117A-V-F3-AX		Embossed Tape 2 500 pcs/reel	(VDE0884 Part2)	
				approved (Option)	

^{*1} For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Diode	Forward Current*1	lF	30	mA
	Reverse Voltage	VR	5	V
Detector	Supply Voltage	Vcc	7	V
	Output Voltage	Vo	7	V
	Output Current	lo	25	mA
	Power Dissipation*2	Pc	40	mW
Isolation Voltage*3		BV	3 750	Vr.m.s.
Operating Ambient Temperature		TA	-40 to +85	°C
Storage Temperature		T _{stg}	−55 to +125	°C

^{*1} Reduced to 0.3 mA/ $^{\circ}$ C at T_A = 25 $^{\circ}$ C or more.

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Low Level Input Voltage	V _{FL}	0		0.8	V
High Level Input Current	lғн	6.3	10	12.5	mA
Supply Voltage	Vcc	4.5	5.0	5.5	V
TTL ($R_L = 1 \text{ k}\Omega$, loads)	N			5	
Pull-up Resistor	R∟	330		4 k	Ω

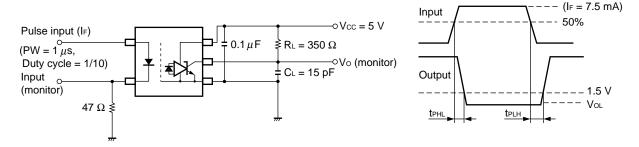
^{*2} Applies to output pin Vo (collector pin). Reduced to 1.5 mW/ $^{\circ}$ C at T_A = 65 $^{\circ}$ C or more.

^{*3} AC voltage for 1 minute at $T_A = 25$ °C, RH = 60% between input and output. Pins 1-2 shorted together, 3-5 shorted together.

ELECTRICAL CHARACTERISTICS (T_A = -40 to +85°C, unless otherwise specified)

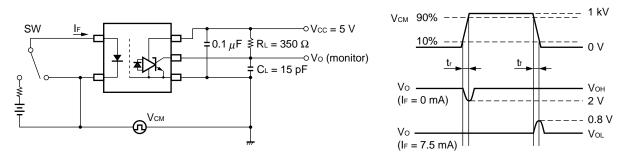
Parameter		Symbol	Conditions	MIN.	TYP. ^{*1}	MAX.	Unit
Diode	Forward Voltage	VF	IF = 10 mA, TA = 25°C	1.4	1.65	1.8	V
	Reverse Current	IR	VR = 3 V, TA = 25°C			10	μА
	Terminal Capacitance	Ct	V = 0 V, f = 1 MHz, T _A = 25°C		30		pF
Detector	High Level Output Current	Іон	Vcc = Vo = 5.5 V, V _F = 0.8 V		1	100	μА
	Low Level Output Voltage*2	Vol	Vcc = 5.5 V, I _F = 5 mA, I _{OL} = 13 mA		0.2	0.6	V
	High Level Supply Current	Іссн	Vcc = 5.5 V, I _F = 0 mA, Vo = open		4	7	mA
	Low Level Supply Current	Iccl	Vcc = 5.5 V, I _F = 10 mA, Vo = open		6	10	
Coupled	Threshold Input Current	IFHL	$Vcc = 5 \text{ V}, Vo = 0.8 \text{ V}, R_L = 350 \Omega$		2	5	
	$(H \rightarrow L)$						
	Isolation Resistance	Ri-o	V _{I-O} = 1 kV _{DC} , RH = 40 to 60%, T _A = 25°C	10 ¹¹			Ω
	Isolation Capacitance	C _{I-O}	V = 0 V, f = 1 MHz, T _A = 25°C		0.6		pF
	Propagation Delay Time	t PHL	T _A = 25°C		40	75	ns
	$(H \rightarrow L)^{*3}$					100	
	Propagation Delay Time	t PLH	T _A = 25°C		45	75	
	$(L \rightarrow H)^{*3}$					100	
	Rise Time	tr	$V_{CC} = 5 \text{ V}, \text{ R}_L = 350 \Omega, \text{ I}_F = 7.5 \text{ mA},$		20		1
	Fall Time	tf	VтннL = VтнLн = 1.5 V		5		
	Pulse Width Distortion (PWD)*3	tphl-tplh			5	35	
	Propagation Delay Skew	t psk				40	
	Common Mode Transient Immunity at High Level Output*4	СМн	$\label{eq:Vcc} \begin{array}{l} \mbox{Vcc} = 5 \mbox{ V, RL} = 350 \ \Omega, \mbox{ TA} = 25 \mbox{°C}, \\ \mbox{IF} = 0 \mbox{ mA, Vo} > 2 \mbox{ V, VcM} = 1 \mbox{ kV} \end{array}$	15	20		kV/μs
	Common Mode Transient Immunity at Low Level Output ^{*4}	CM∟	$V_{CC} = 5$ V, $R_L = 350$ Ω, $T_A = 25$ °C, $I_F = 7.5$ mA, $V_{C} < 0.8$ V, $V_{CM} = 1$ kV	15	20		kV/μs

- *1 Typical values at T_A = 25°C
- *2 Because Vol of 2 V or more may be output when LED current input and when output supply of Vcc = 2.6 V or less, it is important to confirm the characteristics (operation with the power supply on and off) during design, before using this device.
- *3 Test circuit for propagation delay time



Remark C_L includes probe and stray wiring capacitance.

*4 Test circuit for common mode transient immunity

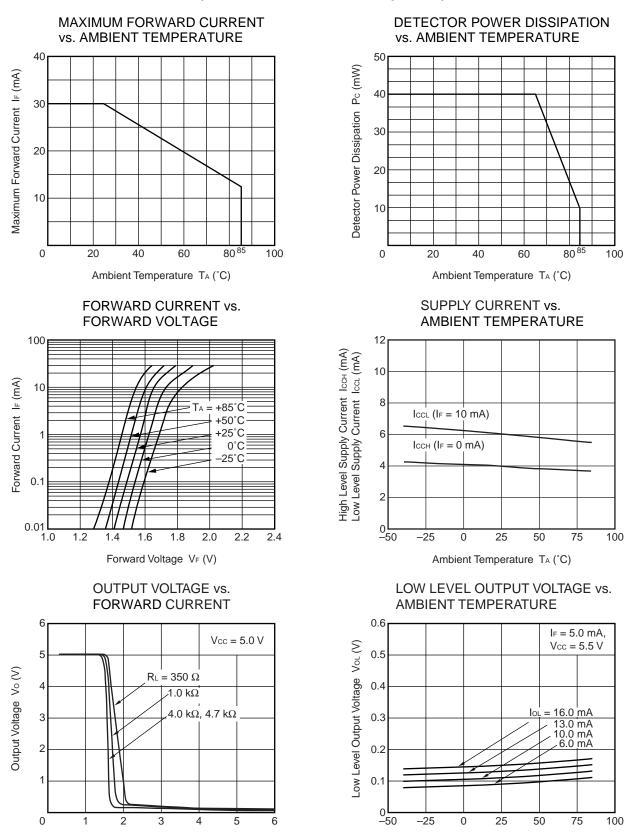


Remark CL includes probe and stray wiring capacitance.

USAGE CAUTIONS

- 1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
- 2. By-pass capacitor of 0.1 μ F is used between Vcc and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
- 3. Avoid storage at a high temperature and high humidity.

TYPICAL CHARACTERISTICS (TA = 25°C, unless otherwise specified)

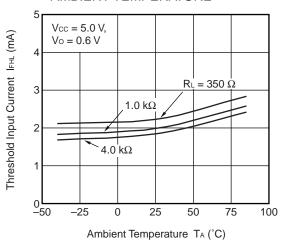


Remark The graphs indicate nominal characteristics.

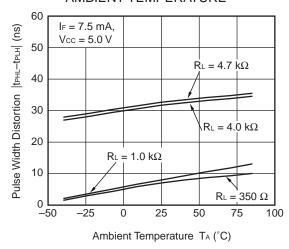
Forward Current IF (mA)

Ambient Temperature TA (°C)

THRESHOLD INPUT CURRENT vs. AMBIENT TEMPERATURE

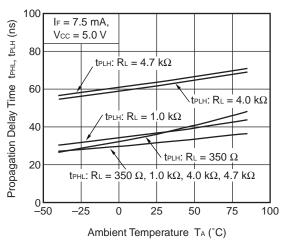


PULSE WIDTH DISTORTION vs. AMBIENT TEMPERATURE

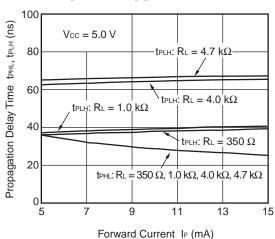


Remark The graphs indicate nominal characteristics.

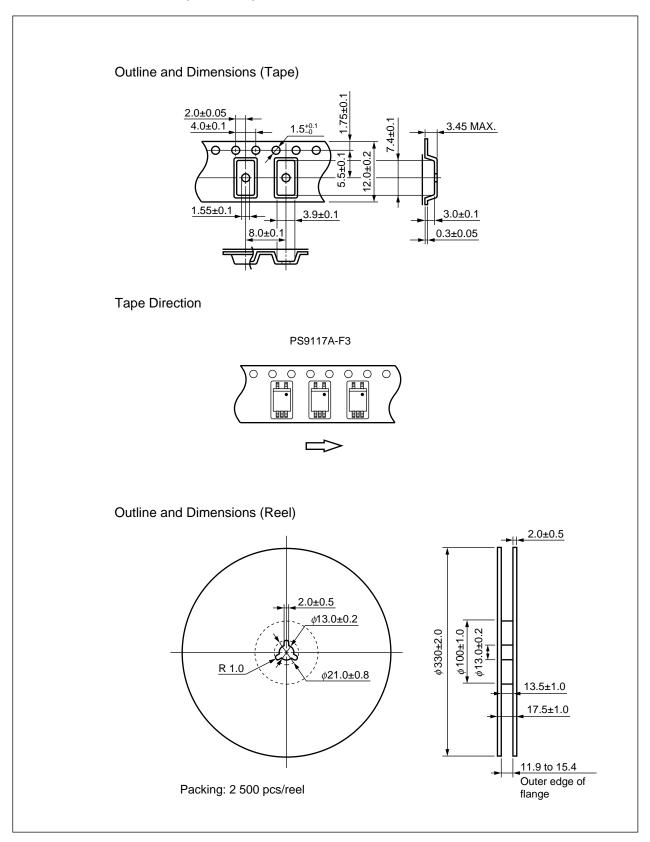
PROPAGATION DELAY TIME vs. AMBIENT TEMPERATURE



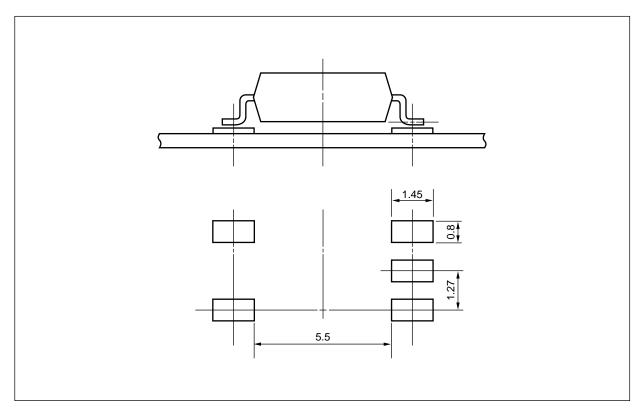
PROPAGATION DELAY TIME vs. FORWARD CURRENT



TAPING SPECIFICATIONS (UNIT: mm)



<R> RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



NOTES ON HANDLING

1. Recommended soldering conditions

(1) Infrared reflow soldering

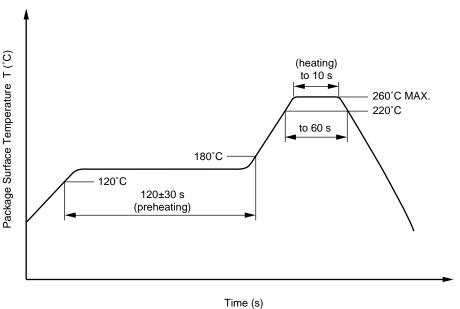
Peak reflow temperature
 260C or below (package surface temperature)

Time of peak reflow temperature 10 seconds or less
 Time of temperature higher than 220C 60 seconds or less

Time to preheat temperature from 120 to 180C 120±30 s
 Number of reflows Three

Flux
 Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(2) Wave soldering

• Temperature 260C or below (molten solder temperature)

• Time 10 seconds or less

Preheating conditions 120C or below (package surface temperature)

Number of times
 One (Allowed to be dipped in solder including plastic mold portion.)

Flux
 Rosin flux containing small amount ofchlorine (The flux with a maximum chlorine)

content of 0.2 Wt% is recommended.)

(3) Soldering by Soldering Iron

Peak Temperature (\(\mathbb{e}\) ad part temperature) 350°C or below
 Time (each pins) 3 seconds or less

Flux
 Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead

(b) Please be sure that the temperature of the package would not be heated over 100°C

(4) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

<R> SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

Parameter	Symbol	Speck	Unit
Application classification (DIN EN 60664-1 VDE0110 Part 1) for rated line voltages \leq 300 Vr.m.s. for rated line voltages \leq 600 Vr.m.s.		IV III	
Climatic test class (DIN EN 60664-1 VDE0110)		40/85/21	
Dielectric strength maximum operating isolation voltage Test voltage (partial discharge test, procedure a for type test and random test) $U_{pr} = 1.5 \times U_{IORM}, P_d < 5 pC$	UIORM Upr	707 1 061	V _{peak} V _{peak}
Test voltage (partial discharge test, procedure b for all devices) $U_{pr} = 1.875 \times U_{IORM}, P_d < 5 pC$	Upr	1 326	V _{peak}
Highest permissible overvoltage	Utr	6 000	V _{peak}
Degree of pollution (DIN EN 60664-1 VDE0110 Part 1)		2	
Clearance distance		>4.2	mm
Creepage distance		>4.2	mm
Comparative tracking index (DIN IEC 112/VDE 0303 Part 1)	СТІ	175	
Material group (DIN EN 60664-1 VDE0110 Part 1)		III a	
Storage temperature range	T _{stg}	-55 to +125	C
Operating temperature range	TA	-40 to +85	C
Isolation resistance, minimum value $V_{IO} = 500 \text{ V dc at T}_A = 25 \text{ C}$ $V_{IO} = 500 \text{ V dc at T}_A \text{ MAX. at least } 100 \text{ C}$	Ris MIN. Ris MIN.	10 ¹² 10 ¹¹	Ω Ω
Safety maximum ratings (maximum permissible in case of fault, see thermal derating curve) Package temperature Current (input current I _F , Psi = 0) Power (output or total power dissipation)	Tsi Isi Psi	150 200 300	℃ mA mW
Isolation resistance Vio = 500 V dc at T _A = Tsi	Ris MIN.	10 ⁹	Ω

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M8E 02.11-1

Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
- Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush,or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.